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## WHAT IS CLAIMED IS:

1. A semiconductor device comprising:

a pixel matrix circuit including at least a plurality of source lines, a plurality of gate lines;

a driver circuit including at least a source line driver circuit for driving the source lines and a gate line driver circuit for driving the gate lines; and

a logic circuit for processing a signal required for driving the driver circuit and a signal including image information transmitted to the pixel matrix circuit,

wherein the pixel matrix circuit, the driver circuit and the logic circuit are disposed over a same substrate,

wherein the pixel matrix circuit, the driver circuit, and the logic circuit are constituted by a plurality of thin film transistors, each having an active layer comprising crystalline silicon, and

wherein the active layer of each of said plurality of thin film transistors comprise a plurality of rod-shaped crystals extending in one direction.

- A semiconductor device according to claim 1 wherein crystal
  lattices said plurality of rod-shaped crystals are continuous within each of the active layer so that there is no barrier for carriers within each of the active layer.
  - 3. A semiconductor device according to claim 1 wherein said device is a liquid crystal display.
- 4. A semiconductor device according to claim 1 wherein said rodshaped crystals have a flattened shape.

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- 5. A semiconductor device according to claim 1 wherein said active layer has an anisotropy between a channel length direction and a channel width direction thereof.
- 6. A semiconductor device according to claim 1 wherein said active layer includes an intrinsic or substantially intrinsic channel forming region.
  - 7. A semiconductor device according to claim 1 wherein said active layer contains an element selected from the group consisting of Ni, Fe, Co, Sn, Pd, Pb, Pt, Cu and Au at a concentration 1 x 1017 atoms/cm3 or lower, said element being capable of promoting crystallization of silicon.
  - 8. A semiconductor device according to claim 1 wherein said active layer contains an element selected from the group consisting of Cl, F, and Br at a concentration from  $1 \times 10^{15}$  to  $1 \times 10^{20}$  atoms/cm<sup>3</sup>.
- 9. A semiconductor device according to claim 8 wherein said 15 element is concentrated at a portion close to a gate insulating film.
  - 10. A semiconductor device according to claim 1 wherein said pixel matrix circuit has a plurality of pixels, and each of said pixels is provided with at least two of said plurality of thin film transistors connected in series.
- 20 11. A semiconductor device according to claim 1 wherein said pixel circuit has a plurality of pixels, each of which is provided with a storage capacitor formed between a connect wiring and a black mask.
  - 12. A semiconductor device according to claim 11 further comprising an organic film having an opening wherein said black mask

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is formed on said organic film and said storage capacitor is formed within said opening.

- 13. A semiconductor device according to claim 11 wherein said connect wiring comprises a same material as a source electrode of each of said thin film transistors, and said connect wiring is formed from a same layer as said source electrode.
- 14. A semiconductor device according to claim 1 wherein one of said thin film transistors constituting said pixel matrix circuit has a different dimension from one of said thin film transistors constituting at least one of said driver circuit and said logic circuit.
- 15. A semiconductor device according to claim 1 wherein said logic circuit includes one or more of a phase comparator, a LPF (low pass filter), a VCO (voltage controlled oscillator), a frequency divider, a horizontal scanning oscillator, a vertical scanning oscillator, a D/A converter, an I/O port, a differential amplifier, an operational amplifier, a comparator and a memory.
  - 16. A semiconductor device comprising:
    - a pixel circuit;
    - a driver circuit for driving said pixel circuit; and
- a logic circuit for processing a signal required for driving the driver circuit, wherein said pixel circuit, said driver circuit and said logic circuit are formed over a same substrate and constituted with a plurality of N-channel type thin film transistors and a plurality of P-channel type thin film transistors;
- wherein subthreshold coefficients of said N-channel thin film transistors and said P-channel thin film transistors are both within a range of 60 to 100 mV/decade.

- 17. A semiconductor device according to claim 16 wherein said pixel circuit has a plurality of pixels arrayed in rows and columns.
  - 18. A semiconductor device comprising:
- a pixel matrix circuit including at least a plurality of source lines, a plurality of gate lines;
  - a driver circuit including at least a source line driver circuit for driving the source lines and a gate line driver circuit for driving the gate lines; and
- a logic circuit for processing a signal required for driving the 10 driver circuit and a signal including image information transmitted to the pixel matrix circuit,

wherein the pixel matrix circuit, the driver circuit and the logic circuit are disposed over a same substrate,

wherein the pixel matrix circuit, the driver circuit, and the logic 15 circuit are constituted by a plurality of thin film transistors, each having an active layer comprising crystalline silicon, and

wherein dimensions of said plurality of thin film transistors are made different depending upon required electrical characteristics by said circuits.

- 20 19. A semiconductor device according to claim 18 wherein said dimensions include at least one of a channel length and a thickness of a gate insulating film.
  - 20. A semiconductor device comprising:
- a pixel matrix circuit including at least a plurality of source 25 lines, a plurality of gate lines;
  - a driver circuit including at least a source line driver circuit for driving the source lines and a gate line driver circuit for driving the gate

lines; and

a logic circuit for processing a signal required for driving the driver circuit and a signal including image information transmitted to the pixel matrix circuit,

wherein the pixel matrix circuit, the driver circuit and the logic circuit are disposed over a same substrate,

wherein the pixel matrix circuit, the driver circuit, and the logic circuit are constituted by a plurality of thin film transistors, each having an active layer comprising crystalline silicon, and

wherein a thickness of a gate insulating film of the thin film transistors which are required to drive a circuit at 0.1 GHz or higher is 500 Å or thinner, and a thickness of a gate insulating film of the thin film transistors which are driven by an operation voltage of 10V or greater is 1000Å or thicker.

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## 21. An active matrix display comprising:

a pixel matrix circuit including at least a plurality of source lines, a plurality of gate lines, and a plurality of TFTs;

a driver circuit including at least a source line driver circuit for driving the source lines and a gate line driver circuit for driving the gate lines; and

a logic circuit for processing a signal required for driving the driver circuit and a signal including image information transmitted to the pixel matrix circuit,

wherein the pixel matrix circuit, the driver circuit and the logic circuit are disposed on the same substrate,

wherein the pixel matrix circuit, the driver circuit, and the logic circuit are constituted by a plurality of TFTs each made of a crystalline silicon thin film, and

wherein a plurality of circuits constituting the pixel matrix circuit, the driver circuit and the logic circuit include at least two kinds

of circuits which are different from each other in a driving frequency and/or an operating voltage.